



## FQP12N60C/FQPF12N60C 600V N-Channel MOSFET

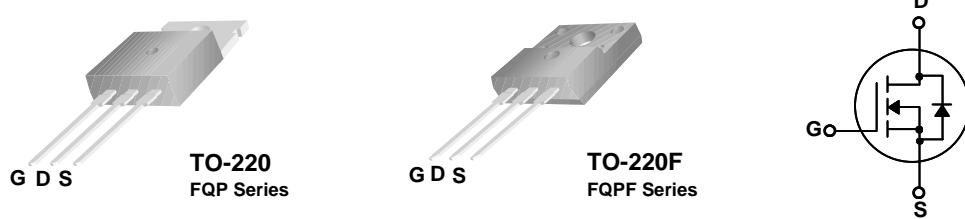
### General Description

These N-Channel enhancement mode power field effect transistors are produced using Corise Semiconductor's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

### Features

- 12A, 600V,  $R_{DS(on)} = 0.65\Omega$  @  $V_{GS} = 10$  V
- Low gate charge ( typical 48 nC)
- Low  $C_{rss}$  ( typical 21 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



### Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$  unless otherwise noted

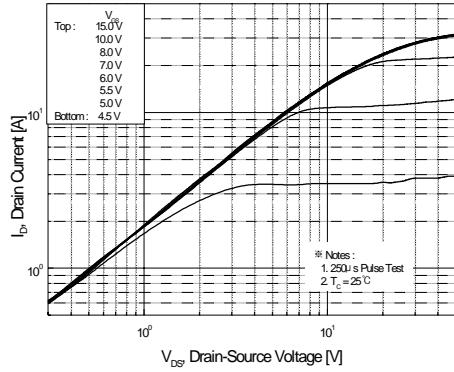
Symbol	Parameter	FQP12N60C	FQPF12N60C	Units
$V_{DSS}$	Drain-Source Voltage	600		V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ )	12	12 *	A
	- Continuous ( $T_C = 100^\circ\text{C}$ )	7.4	7.4 *	A
$I_{DM}$	Drain Current - Pulsed (Note 1)	48	48 *	A
$V_{GSS}$	Gate-Source Voltage	$\pm 30$		V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	870		mJ
$I_{AR}$	Avalanche Current (Note 1)	12		A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	22.5		mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)	4.5		V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	225	51	W
	- Derate above $25^\circ\text{C}$	1.78	0.41	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$

\* Drain current limited by maximum junction temperature.

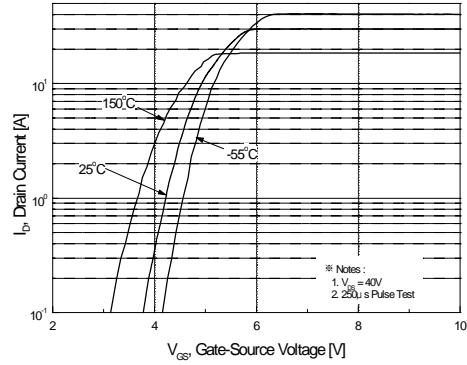
### Thermal Characteristics

Symbol	Parameter	FQP12N60C	FQPF12N60C	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.56	2.43	$^\circ\text{C}/\text{W}$
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

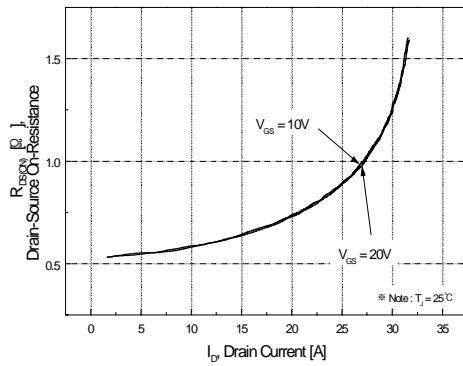
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 µA	600	--	--	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 µA, Referenced to 25°C	--	0.5	--	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	--	--	1	µA
		V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125°C	--	--	10	µA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V	--	--	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 µA	2.0	--	4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A	--	0.53	0.65	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 6 A (Note 4)	--	13	--	S
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	--	1760	2290	pF
C <sub>oss</sub>	Output Capacitance		--	182	235	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	21	28	pF
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 12 A, R <sub>G</sub> = 25 Ω (Note 4, 5)	--	30	70	ns
t <sub>r</sub>	Turn-On Rise Time		--	85	180	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	155	120	ns
t <sub>f</sub>	Turn-Off Fall Time		--	90	190	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V (Note 4, 5)	--	48	63	nC
Q <sub>gs</sub>	Gate-Source Charge		--	8.5	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	21	--	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current	--	--	12	--	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current	--	--	48	--	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12 A	--	--	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12 A, dI <sub>F</sub> / dt = 100 A/µs (Note 4)	--	420	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	4.9	--	µC
<b>Notes:</b>						
1.	Repetitive Rating : Pulse width limited by maximum junction temperature					
2.	L = 11mH, I <sub>AS</sub> = 12A, V <sub>DD</sub> = 50V, R <sub>G</sub> = 25 Ω, Starting T <sub>J</sub> = 25°C					
3.	I <sub>SD</sub> ≤ 12A, dI/dt ≤ 200A/µs, V <sub>DD</sub> ≤ BV <sub>DSS</sub> , Starting T <sub>J</sub> = 25°C					
4.	Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%					
5.	Essentially independent of operating temperature					



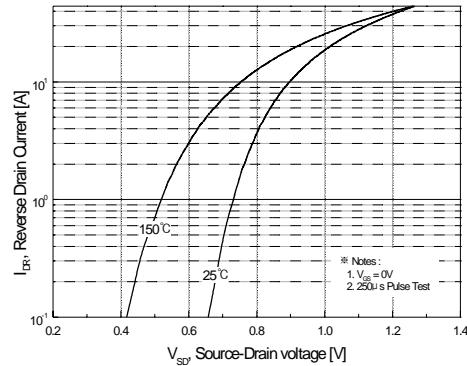
**Figure 1. On-Region Characteristics**



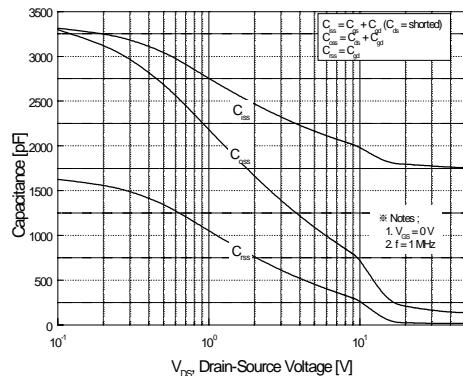
**Figure 2. Transfer Characteristics**



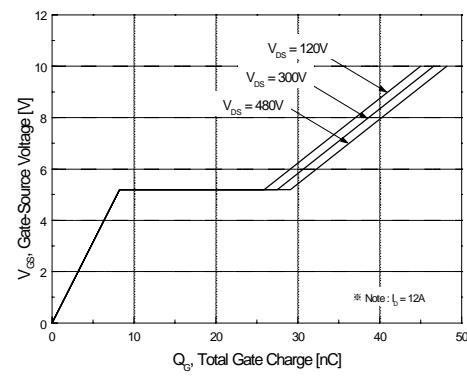
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



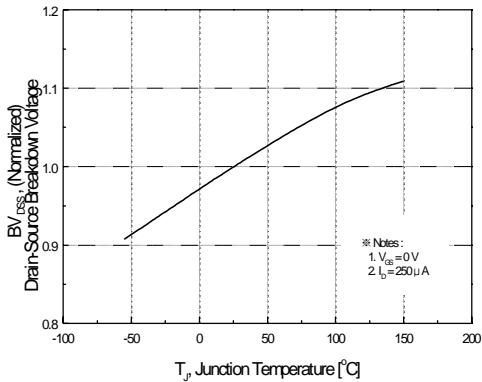
**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**



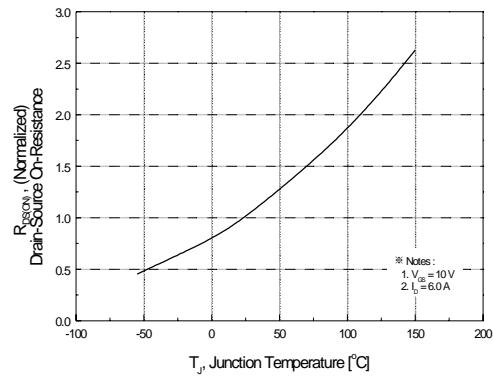
**Figure 5. Capacitance Characteristics**



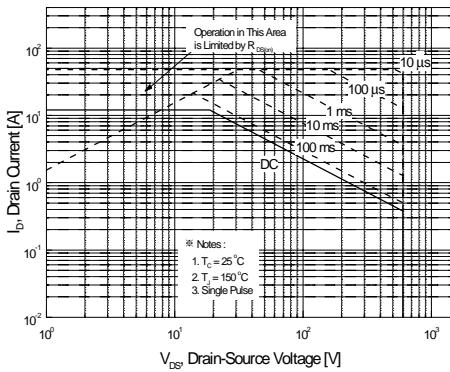
**Figure 6. Gate Charge Characteristics**



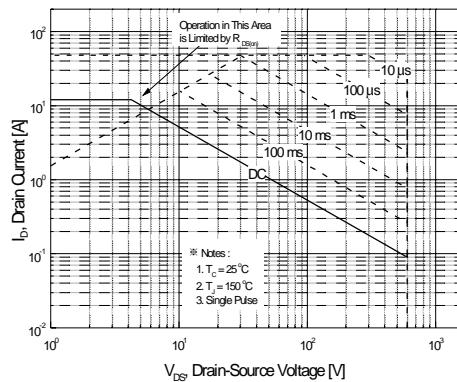
**Figure 7. Breakdown Voltage Variation  
vs Temperature**



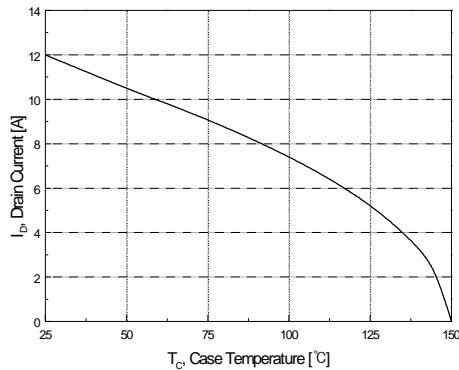
**Figure 8. On-Resistance Variation  
vs Temperature**



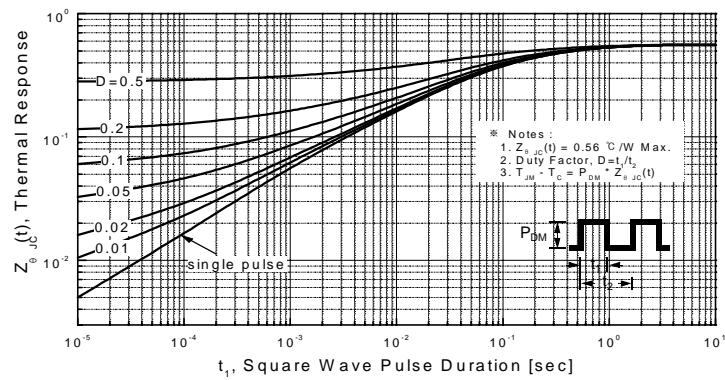
**Figure 9-1. Maximum Safe Operating Area  
for FQP12N60C**



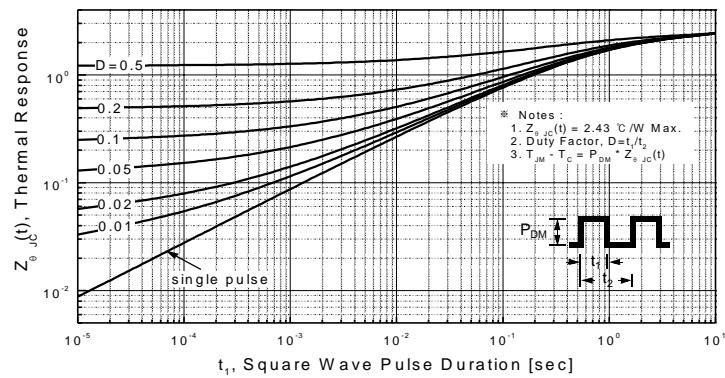
**Figure 9-2. Maximum Safe Operating Area  
for FQPF12N60C**



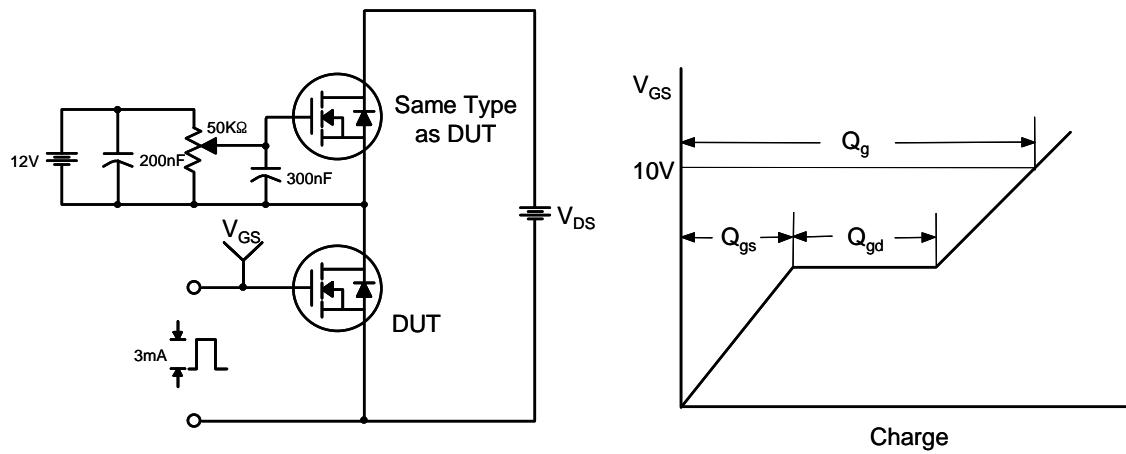
**Figure 10. Maximum Drain Current  
vs Case Temperature**



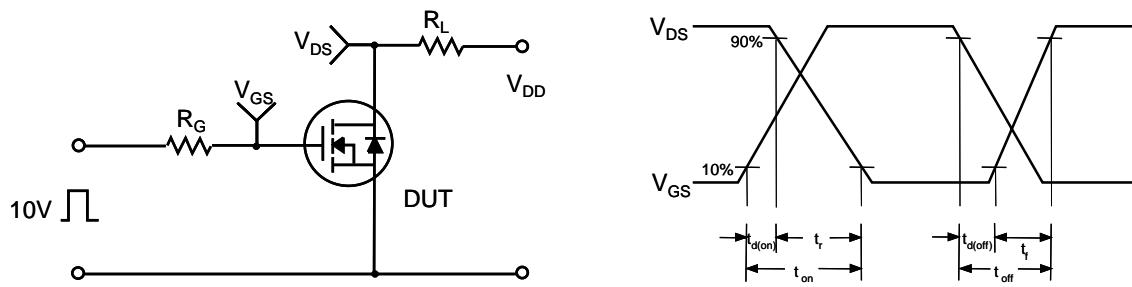
**Figure 11-1. Transient Thermal Response Curve for FQP12N60C**



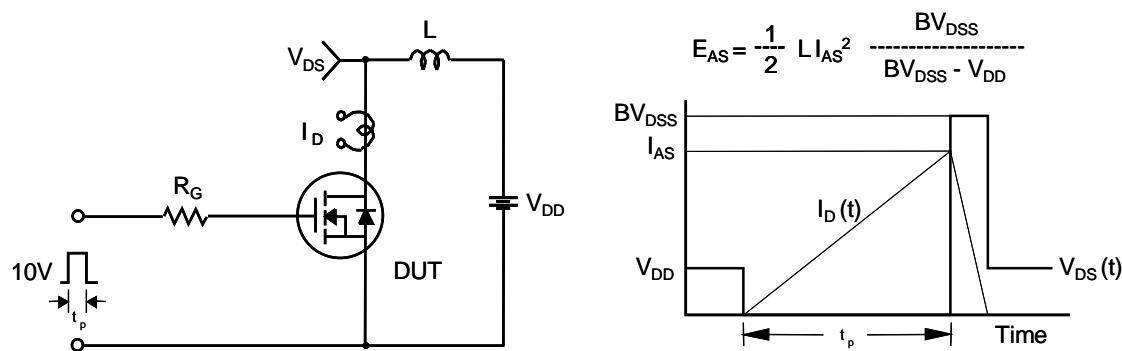
**Figure 11-2. Transient Thermal Response Curve for FQPF12N60C**



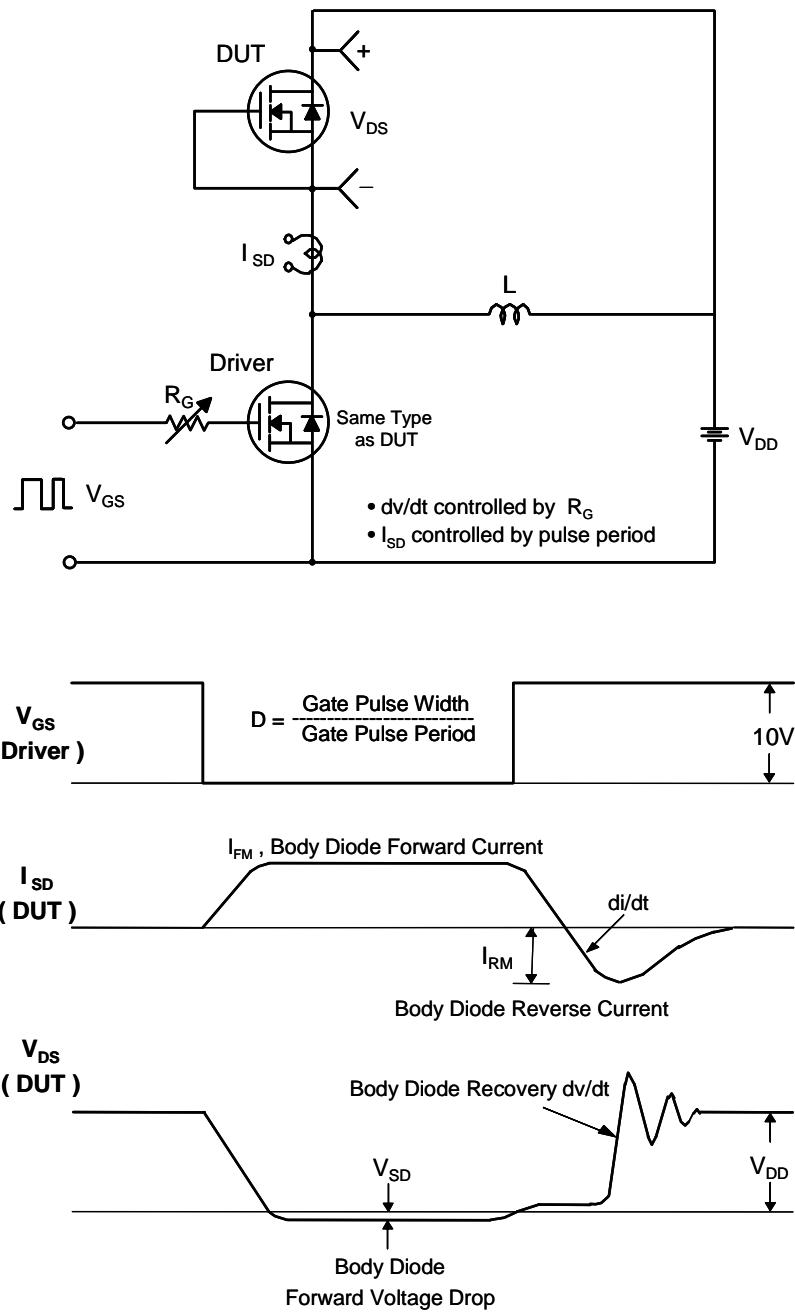
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

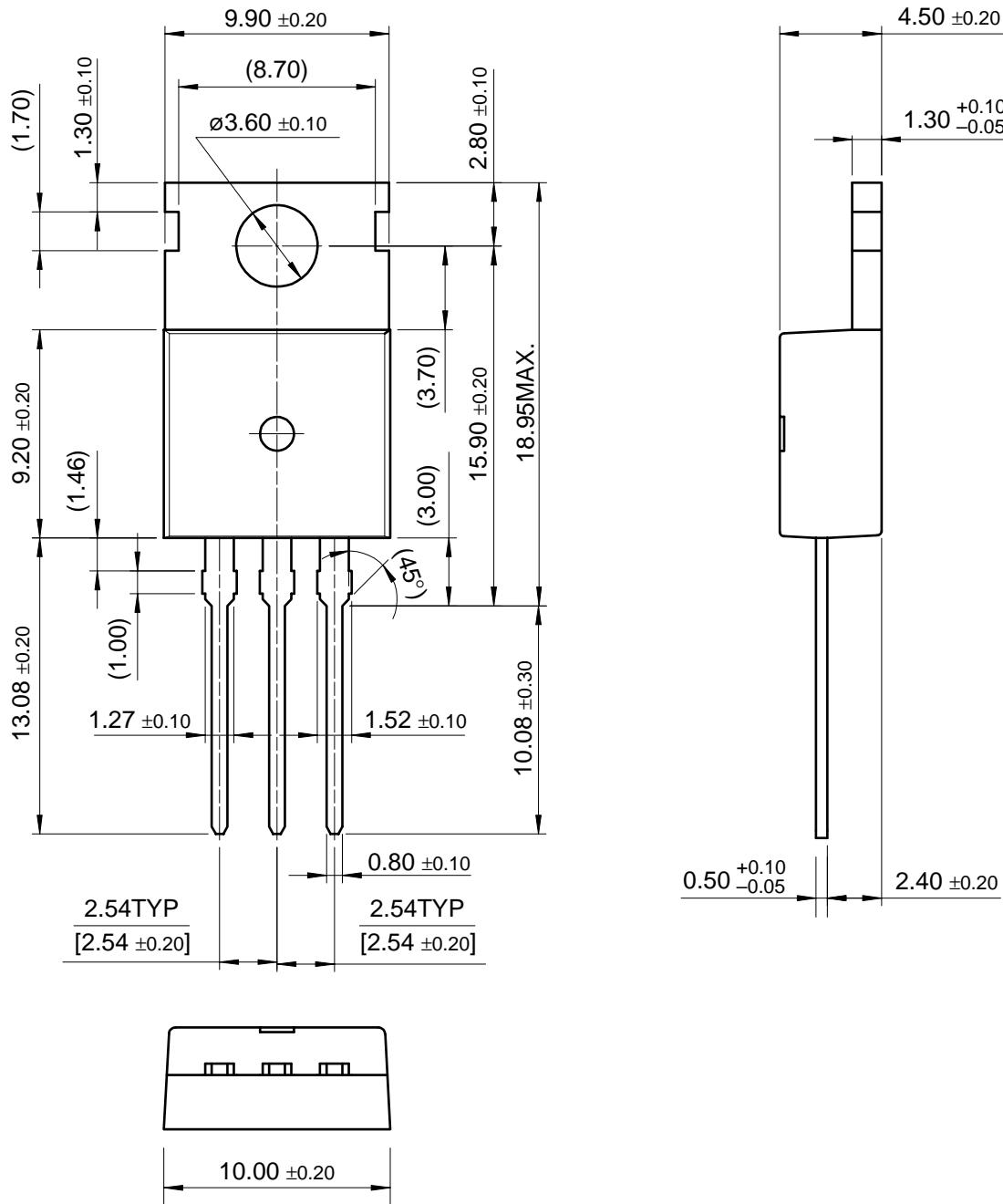


# FQP12N60C/FQPF12N60C



**FQQP12N60C/FQPF12N60C**

**TO-220**



**FQP12N60C/FQPF12N60C**

**TO-220F**

